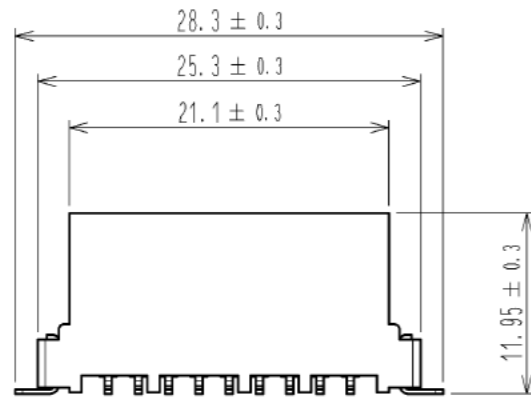
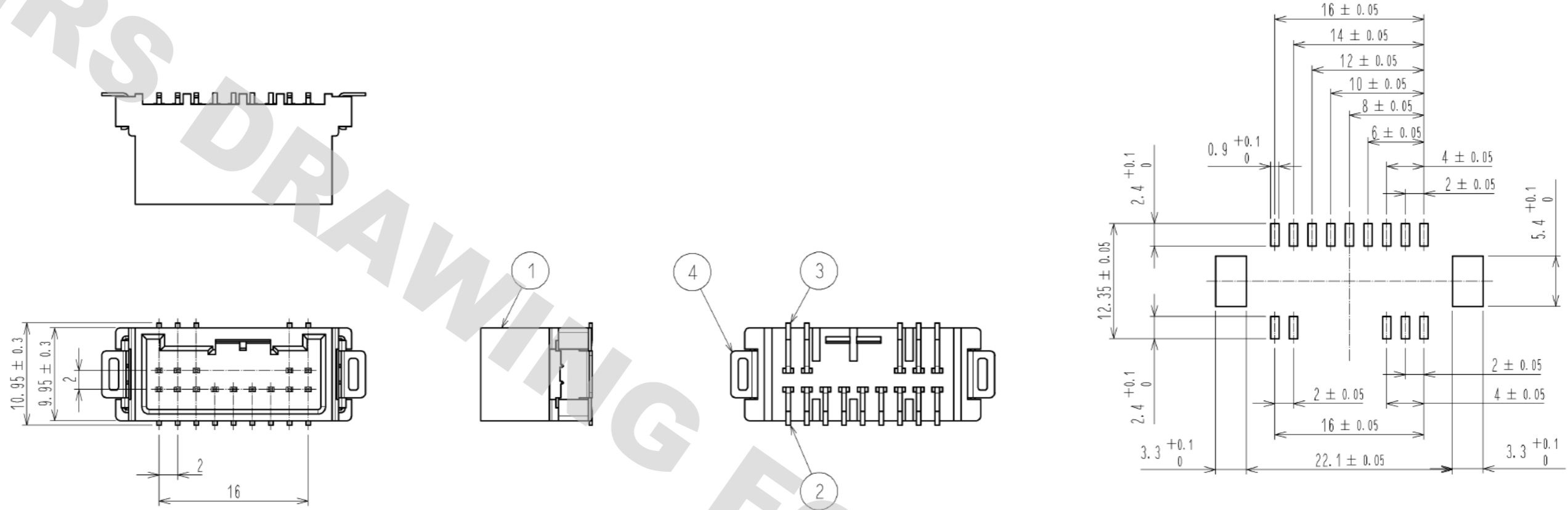


ELV. RoHS COMPLIANT



NOTE 1. RECOMMENDED TEMPERATURE PROFILE FOR REFLOW (REFER RIGHT FIG.).

REFLOW HEATING: FAR-INFLARED, IN THE AIR OR NITROGEN

REFLOW No. : MAX 2 TIMES

PEAK TEMPERATURE: 250°C

ABOVE 230°C: 20~40s

PREHEAT: 150~180°C (60~120s)

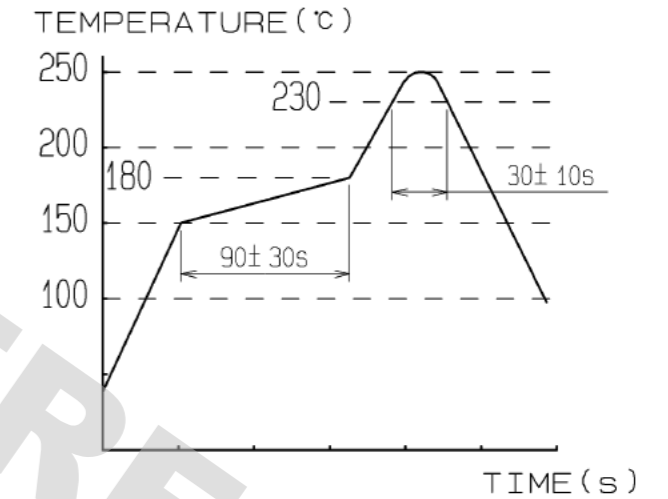
2. SOLDERING TEMPERATURE: 280~300°C (MAX 2s)

3. COPLANARITY OF LEADS SHALL BE UNDER 0.1mm.

4. RECOMMENDED THICKNESS FOR PC BOARD IS 1.6mm.

5. RECOMMENDED THICKNESS FOR SOLDER PASTE IS 0.15mm.

6. TIN PLATING, PARTIAL GOLD PLATING (CONTACT AREA)



2	BRASS	NOTE 6	4	BRASS	TIN PLATING
1	PPS	BLACK	3	BRASS	NOTE 6
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT 	DESCRIPTION OF REVISIONS	DESIGNED
HRS HIROSE ELECTRIC CO., LTD.		APPROVED : AR. SHIRAI	11.12.22	DRAWING NO.	EDC3-168823-01
		CHECKED : AR. SHIRAI	11.12.22	PART NO.	GT8EH-14DP-2V(C01)
		DESIGNED : NA. HARUBAYASHI	11.12.22	CODE NO.	CL758-0225-5-01
		DRAWN : NA. HARUBAYASHI	11.12.22		1/1

DRAWING FOR REFERENCE: This is subject to change without notice
05/31/2013

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Hirose Electric:](#)

[GT8EH-14DP-2V\(01\)](#)